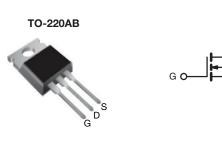
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.6			
Q _g max. (nC)	48				
Q _{gs} (nC)	6				
Q _{gd} (nC)	11				
Configuration	Single				



S N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

OORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and Halogen-free	SiHP6N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	650	V	
Gate-Source Voltage			V _{GS}	± 30	v	
Continuous Drain Current (T. 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		7		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	V _{GS} at 10 V	T _C = 100 °C	I _D	5	A	
Pulsed Drain Current ^a		I _{DM}	18			
Linear Derating Factor				0.63	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	56	mJ	
Maximum Power Dissipation			PD	78	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C			37		
everse Diode dV/dt ^d		dV/dt	27	V/ns		
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_g = 25 \Omega$, $I_{AS} = 2$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

1 For technical questions, contact: <u>hvm@vishay.com</u>



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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		62		°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	- 1.6					
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static					•	•	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D =	250 µA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.73	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2	-	4	V
Cata Cauraa Laakaga			$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA	
Zaro Cato Voltago Drain Current	la a a	$\begin{tabular}{ c c c c c } \hline $V_{DS} = 650 V, $V_{GS} = 0 V \\ \hline $V_{DS} = 520 V, $V_{GS} = 0 V, $T_J = 125 $^{\circ}C$ \\ \hline $V_{GS} = 10 V & $I_D = 3 A \\ \hline \end{tabular}$		-	-	1	μA	
Zero Gate Voltage Drain Current	I _{DSS}			-	-	10		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		I _D = 3 A	-	0.5	0.6	Ω
Forward Transconductance	9 _{fs}	V _{DS}	_s = 30 V, I _D	= 3 A	-	2	-	S
Dynamic								
Input Capacitance	C _{iss}		$V_{GS} = 0 V$		-	820	-	
Output Capacitance	C _{oss}	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		-	1			
Reverse Transfer Capacitance	C _{rss}			-	4	-	pF	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 520 V, V _{GS} = 0 V		-	36	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$v_{\rm DS} = 0.0$	7 to 520 v,	v _{GS} = 0 v	-	117	-	
Total Gate Charge	Qg				-	24	48	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 3 /	A, V _{DS} = 520 V	-	6	-	nC
Gate-Drain Charge	Q _{gd}				-	11	-	
Turn-On Delay Time	t _{d(on)}				-	14	28	
Rise Time	t _r	$V_{GS} = 10 V$ $I_D = 3 A, V_{DS} = 520 V$ $V_{DD} = 520 V, I_D = 3 A,$		-	12	24		
Turn-Off Delay Time	t _{d(off)}		= 10 V, R _g :		-	30	60	ns
Fall Time	t _f			-	20	40		
Gate Input Resistance	R _g	f = 1	MHz, ope	n drain	-	1.4	-	Ω
Drain-Source Body Diode Characterist	ics							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	7		
Pulsed Diode Forward Current	I _{SM}	J	integral reverse p - n junction diode		-	-	18	A
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 3 A	, V _{GS} = 0 V	-	-	1.3	V
Reverse Recovery Time	t _{rr}				-	237	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	25 °C, I _F = I 100 A/µs, '	$_{\rm S} = 3 {\rm A},$	-	2.2	-	μC
Reverse Recovery Current	I _{RRM}		του Avµs,	$v_{\rm R} = 20 v$	-	16	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

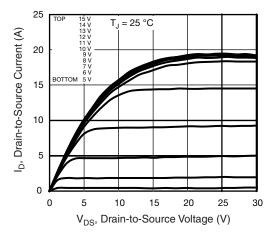


Fig. 1 - Typical Output Characteristics

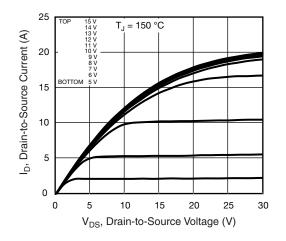


Fig. 2 - Typical Output Characteristics

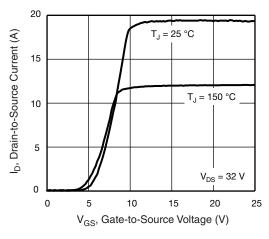


Fig. 3 - Typical Transfer Characteristics

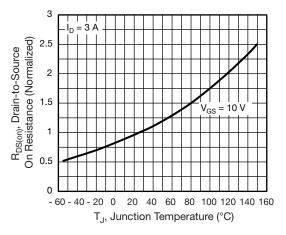


Fig. 4 - Normalized On-Resistance vs. Temperature

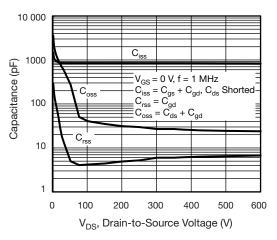


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

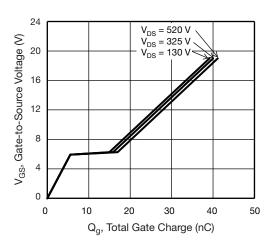


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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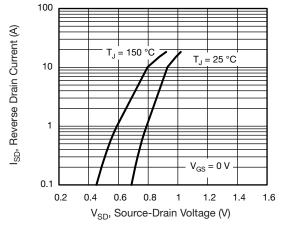


Fig. 7 - Typical Source-Drain Diode Forward Voltage

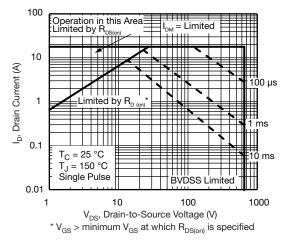


Fig. 8 - Maximum Safe Operating Area

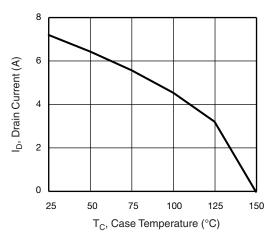


Fig. 9 - Maximum Drain Current vs. Case Temperature

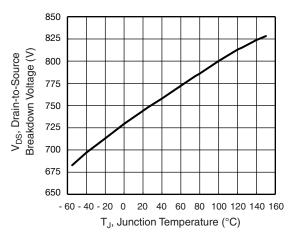
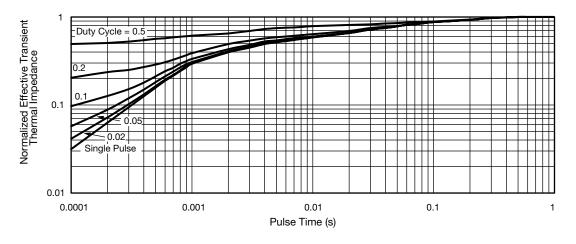
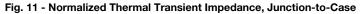


Fig. 10 - Temperature vs. Drain-to-Source Voltage





S15-0399-Rev. B, 16-Mar-15

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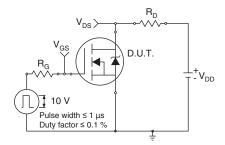


Fig. 12 - Switching Time Test Circuit

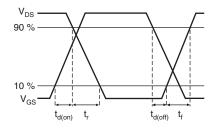


Fig. 13 - Switching Time Waveforms

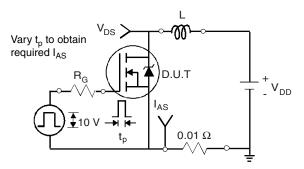


Fig. 14 - Unclamped Inductive Test Circuit

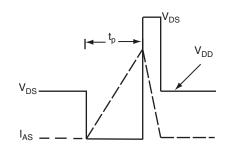


Fig. 15 - Unclamped Inductive Waveforms

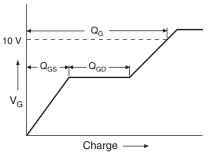


Fig. 16 - Basic Gate Charge Waveform

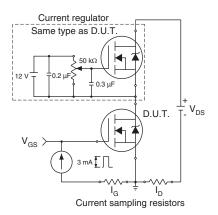


Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

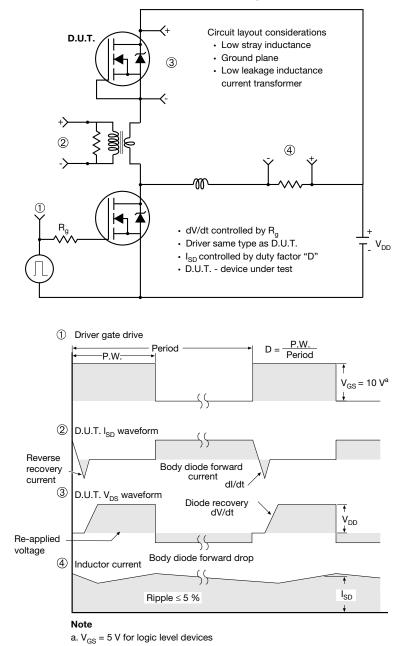


Fig. 18 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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